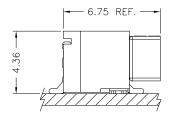


### Specifications

Current Rating:  $0.5A\sim1A$  AC,DC(Per Pin) Voltage Rating: 50V AC,DC(Per Pin) Temperature Range:  $-25^{\circ}C \sim +85^{\circ}C$  Contact Resistance:  $20m\Omega$  Max. Insulation Resistance:  $100M\Omega$  Min. Withstanding Voltage: 500V AC/minute

**Standards** 

## **Assembly Layout**



### Ordering Code



- 1 Series No.
- 2 Plating Code: G=Gold-Plated
- 3 Material: P=Phosphor Bronze
- 4 E=Stamping Before Plating



Series No.

Housing Type: H=Housing

2X=Dual Row No. of Circuits



- 1 Series No.
- 2 Connector Type: WR=Right Angle
- ③ A=A Type
- 4 Mounting Type: S=SMT
- 5 2X=Dual Row
- 6 No. of Circuits

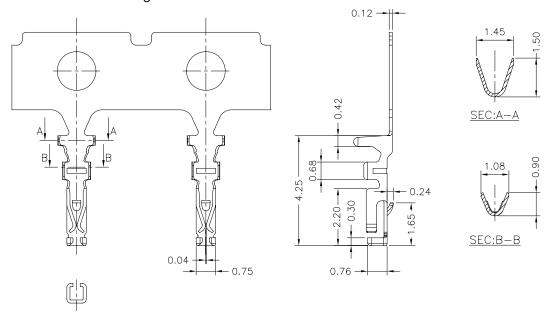


### A1013-XXX

1.00mm Pitch Crimp Terminal

#### **Reference Information:**

\*Used in A1013 Series Housing



Ordering Information & Specifications:

Unit:mm

Part No.	Wire Range	Insulation O.D.	Material	Finish	Qty/Reel
A1013-GPE	AWG#28-#32	0.80mm(Max)	Phosphor Bronze	Gold-Plated	15,000Pcs

Note:E-Stamping Before Plating

A1013H-2

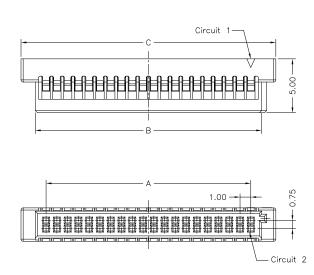
-1.00mm Pitch Dual Row Housing

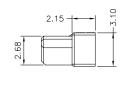
#### **Reference Information:**

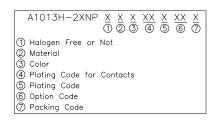
\*Material: Thermoplastic

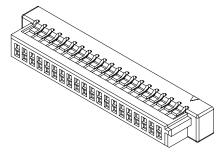
\*Suitable A1013 Series Terminal

\*Mates with A1013 Series Dual Row Wafer









#### Dimensions:

Circuit No.	Dimensions				
Circuit No.	Α	В	С		
2X15	14.00	16.00	18.65		
2X20	19.00	21.00	23.65		

Unit:mm

# A1013WRA-S-2

-1.00mm Pitch 90° Dual Row Wafer- SMT Type

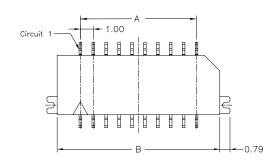
### **Reference Information:**

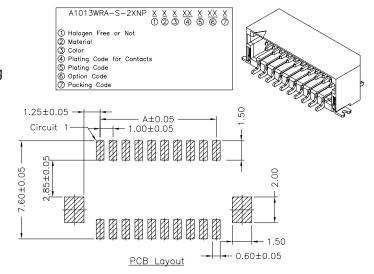
\*Material: Pin: Copper Alloy

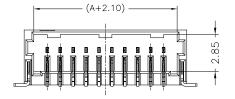
Solder Tabs: Copper Alloy

Wafer: Thermoplastic

\*Mates with A1013 Series Dual Row Housing









#### Dimensions:

Circuit No.	Dimensions		
Circuit No.	Α	В	
2X10	9.00	12.60	
2X15	14.00	17.60	
2X20	19.00	22.60	

Unit:mm